

# HSF

**NOTES:**

Rated Current:1.0AMP  
 Contact Resistance:20mΩ max  
 Withstand Voltage:500V AC/minute  
 Insulation Resistance:1000MΩ min  
 Operation Temperature:-40°C to +105°C

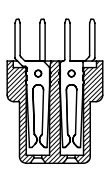
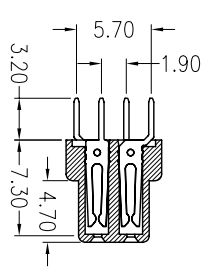
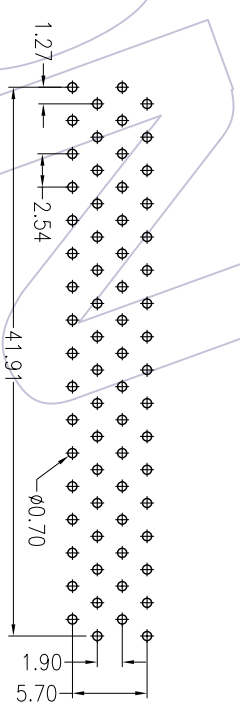
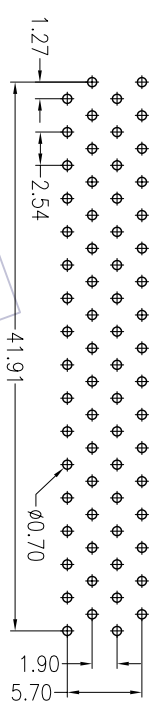
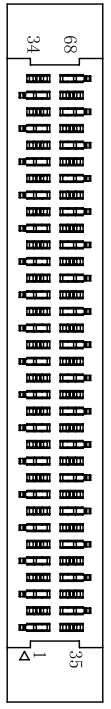
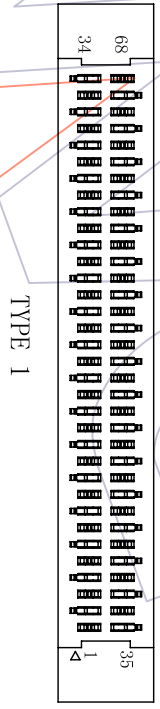
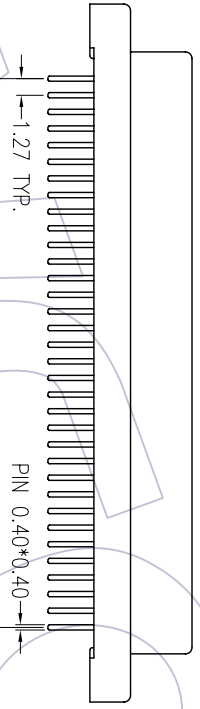
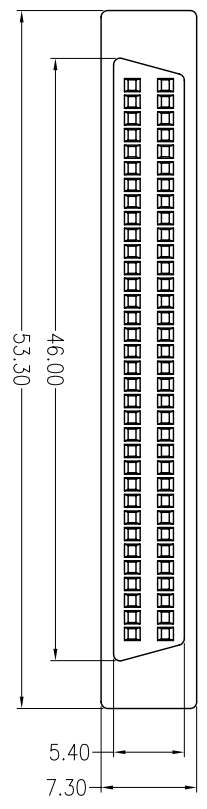
Contact Material:Phosphor Bronze  
 Contact Plating:Au or Sn Over Ni  
 Insulator Material:Polyester(Ul94V-0)

## Ordering Information

6311 - 068 S D XX P 01

No. of Pins per  
068=68PIN

- Contact Plating  
 G0=Gold Flash  
 G1=3u"Gold  
 G2=5u"Gold  
 G3=10u"Gold  
 G4=15u"Gold  
 G5=30u"Gold  
 S0=Gold Flash/Tin  
 S1=3u"Gold/Tin  
 S2=5u"Gold/Tin  
 S3=10u"Gold/Tin  
 S4=15u"Gold/Tin  
 S5=30u"Gold/Tin  
 SN=Tin



TYPE 2

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION		DRAW	WEIXD	09.02.16	SCALE		PART NO.	TITLE:
					DIM	TOL				UNIT	mm		
A0	09/02/16	NEW			X.X	±0.40	DESIGN			1:1	A4	6311-068SDXXP01	68P FEMALE SCSI D-SUB 180° DIP
					X.XX	±0.25	CHECK				1/2		
					X.XXX	±0.15							
					Angle	± 3'	APPROVE						

**WCON** 维峰五金电子有限公司  
 WAFE HARDWARE ELECTRONICS CO. LTD

Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)